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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re application of: DESAI et al.

Attorney Docket No.:  
03-2198/LSI1P242

Application No.: 10/820,494

Examiner: SEFER, Ahmed N.

Filed: April 7, 2004

Group: 2826

TITLE: METHOD AND APPARATUS  
FOR ESTABLISHING IMPROVED THERMAL  
COMMUNICATION BETWEEN A DIE AND A  
HEATSPREADER IN A SEMICONDUCTOR  
PACKAGE

Confirmation No.: 7404

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I hereby certify that this correspondence is being transmitted by facsimile to fax number 571-273-8300 to the U.S. Patent and Trademark Office on January 10, 2006.

Signed: 

Sue Funchess

**AMENDMENT B**Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Final Office Action dated November 16, 2005, please amend the above-identified patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 4 of this paper.

Remarks/Arguments begin on page 7 of this paper.

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